Features

- 32.768 kHz ±5, ±10, ±20 ppm frequency stability options over temp
- World's smallest TCXO in a 1.5 x 0.8 mm CSP
- Operating temperature ranges:
 - 0°C to +70°C
 - -40°C to +85°C
- Ultra-low power: <1 µA
- Vdd supply range: 1.5V to 3.63V
- Improved stability reduces system power with fewer network timekeeping updates
- NanoDrive[™] programmable output swing for lowest power and direct XTAL SoC input interface
- Internal filtering eliminates external Vdd bypass cap and saves space
- Pb-free, RoHS and REACH compliant

Applications

- Smart Meters (AMR)
- Health and Wellness Monitors
- Pulse-per-Second (pps) Timekeeping
- RTC Reference Clock



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Electrical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Frequency and Stability						
Output Frequency	Fout		32.768		kHz	
Frequency Stability Over		-5.0		5.0		Stability part number code = E
Temperature ^[1]	F_stab	-10		10	ppm	Stability part number code =F
(without Initial Offset ^[2])		-20		20		Stability part number code =1
Frequency Stability Over	F_stab	-10		10		Stability part number code = E
Temperature	F_SIAD	-13		13	ppm	Stability part number code = F
(with Initial Offset ^[2])		-22		22		Stability part number code =1
Frequency Stability vs Voltage	F_vdd	-0.75		0.75	ppm	1.8V ±10%
Frequency Stability vs voltage	1_100	-1.5		1.5	ppm	1.5V – 3.63V
First Year Frequency Aging		-1.0		1.0	ppm	
10-year Aging	F_aging		1.5		ppm	T _A = 25°C, Vdd = 1.8 to 3.3V
20-year Aging			2.0		ppm	
			Jitter Perf	formance (T	A = over ter	np)
Long Term Jitter				2.5	μs _{pp}	81920 cycles (2.5 sec), 100 samples
Period Jitter			35		ns _{RMS}	Cycles = 10,000, $T_A = 25^{\circ}C$, Vdd = 1.5V - 3.63V
		S	Supply Volta	ge and Curi	ent Consur	nption
Operating Supply Voltage	Vdd	1.5		3.63	V	$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$
0	ldd		0.99			$T_A = 25^{\circ}C$, Vdd = 1.8V, LVCMOS Output configuration, No Load
Core Supply Current ^[3]				1.52	μA	$T_A = -40^{\circ}C$ to +85°C, Vdd = 1.5V - 3.63V, No Load
Power-Supply Ramp	t_Vdd_ Ramp			100	ms	Vdd Ramp-Up 0 to 90% Vdd, $T_A = -40^{\circ}C$ to +85°C
	t_start		180	300	ms	$T_A = -40^{\circ}C + 60^{\circ}C$, valid output
Start-up Time at Power-up				350		T_A = +60°C to +70°C, valid output
				380		$T_A = +70^{\circ}C$ to +85°C, valid output

Notes:

1. No board level underfill. Measured as peak-to-peak/2. Inclusive of 3x-reflow and ±20% load variation. Tested with Agilent 53132A frequency counter. Due to the low operating frequency, the gate time must be ≥100 ms to ensure an accurate frequency measurement.

2. Initial offset is defined as the frequency deviation from the ideal 32.768 kHz at room temperature, post reflow.

3. Core operating current does not include output driver operating current or load current. To derive total operating current (no load), add core operating current + output driver operating current, which is a function of the output voltage swing. See the description titled, **Calculating Load Current**.

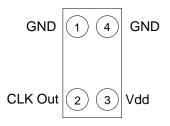
Electrical Characteristics (continued)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Operating Temperature Range						
Commercial Temperature	Op Temp	0		70	°C	
Industrial Temperature	Ob [_] remb	-40		85	°C	
				LVCMOSO	utput	
Output Rise/Fall Time	tr, tf		100	200	ns	10-90% (Vdd), 15 pF Load
	u, u			50	115	10-90% (Vdd), 5 pF Load, Vdd ≥1.62V
Output Clock Duty Cycle	DC	48		52	%	
Output Voltage High	VOH	90%			V	Vdd: 1.5V – 3.63V. I _{OH} = -1 µA, 15 pF Load
Output Voltage Low	VOL			10%	V	Vdd: 1.5V – 3.63V. I _{OL} = 1 µA, 15 pF Load
		NanoD	rive™ Prog	rammable,	Reduced S	wing Output
Output Rise/Fall Time	tf, tf			200	ns	30-70% (V _{OL} /V _{OH}), 10 pF Load
Output Clock Duty Cycle	DC	48		52	%	
AC-coupled Programmable Output Swing	V_sw		0.20 to 0.80		V	SiT1552 does not internally AC-couple. This output description is intended for a receiver that is AC-coupled. See Table x for acceptable NanoDrive swing options. Vdd: 1.5V - 3.63V, 10 pF Load, $I_{OH} / I_{OL} = \pm 0.2 \mu$ A.
DC-Biased Programmable Output Voltage High Range	VOH		0.60 to 1.225		V	Vdd: 1.5V – 3.63V. I_{OH} = -0.2 $\mu A,$ 10 pF Load. See Table 1 for acceptable V_{OH}/V_{OL} setting levels.
DC-Biased Programmable Output Voltage Low Range	VOL		0.35 to 0.80		V	Vdd: 1.5V – 3.63V. I_{OL} = 0.2 $\mu A,$ 10 pF Load. See Table 1 for acceptable V_{OH}/V_{OL} setting levels.
Programmable Output Voltage Swing Tolerance		-0.055		0.055	V	$T_A = -40^{\circ}C$ to +85°C, Vdd = 1.5V to 3.63V.

Pin Configuration

CSP Pin	Symbol	I/O	Functionality
1, 4	GND	Power Supply Ground	Connect to ground. All GND pins must be connected to power supply ground. The GND pins can be connected together, as long as both GND pins are connected ground.
2	CLK Out	OUT	Oscillator clock output. When interfacing to an MCU's XTAL, the CLK Out is typically connected to the receiving IC's X IN pin. The SiT1552 oscillator output includes an internal driver. As a result, the output swing and operation is not dependent on capacitive loading. This makes the output much more flexible, layout independent, and robust under changing environmental and manufacturing conditions.
3	Vdd	Power Supply	Connect to power supply $1.5V \le Vdd \le 3.63V$. Under normal operating conditions, Vdd does not require external bypass/decoupling capacitor(s). For more information about the internal power-supply filtering, see <i>Power-Supply Noise Immunity</i> section in the detailed description. Contact factory for applications that require a wider operating supply voltage range.

CSP Package (Top View)



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System Block Diagram

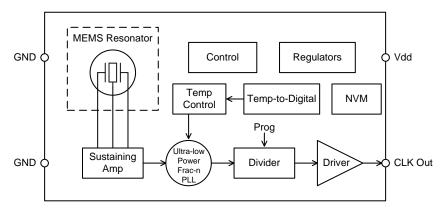


Figure 1.

Absolute Maximum

Attempted operation outside the absolute maximum ratings cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Test Condition	Value	Unit	
Continuous Power Supply Voltage Range (Vdd)		-0.5 to 3.63	V	
Short Duration Maximum Power Supply Voltage (Vdd)	≤30 minutes	4.0	V	
Continuous Maximum Operating Temperature Range	Vdd = 1.5V - 3.63V	105	°C	
Short Duration Maximum Operating Temperature Range	Vdd = 1.5V - 3.63V, ≤30 mins	125	°C	
Human Body Model (HBM) ESD Protection	JESD22-A114	3000	V	
Charge-Device Model (CDM) ESD Protection	JESD22- C101	750	V	
Machine Model (MM) ESD Protection	JESD22- A115	300	V	
Latch-up Tolerance	JESD78 Compliant			
Mechanical Shock Resistance	Mil 883, Method 2002	10,000	g	
Mechanical Vibration Resistance	Mil 883, Method 2007	70	g	
1508 CSP Junction Temperature		150	°C	
Storage Temperature		-65°C to 1	50°C	

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Description

The SiT1552 is an ultra-small and ultra-low power 32.768 kHz TCXO optimized for battery-powered applications. SiTime's silicon MEMS technology enables the first 32 kHz TCXO in the world's smallest footprint and chip-scale packaging (CSP). Typical core supply current is only 1 μ A. And unlike standard oscillators, the SiT1552 features NanoDriveTM, a factory programmable output that reduces the voltage swing to minimize power.

SiTime's MEMS oscillators consist of MEMS resonators and a programmable analog circuit. Our MEMS resonators are built with SiTime's unique MEMS First[™] process. A key manufacturing step is EpiSeal[™] during which the MEMS resonator is annealed with temperatures over 1000°C. EpiSeal creates an extremely strong, clean, vacuum chamber that encapsulates the MEMS resonator and ensures the best performance and reliability. During EpiSeal, a poly silicon cap is grown on top of the resonator cavity, which eliminates the need for additional cap wafers or other exotic packaging. As a result, SiTime's MEMS resonator die can be used like any other semiconductor die. One unique result of SiTime's MEMS First and EpiSeal manufacturing processes is the capability to integrate SiTime's MEMS die with a SOC, ASIC, microprocessor or analog die within a package to eliminate external timing components and provide a highly integrated, smaller, cheaper solution to the customer.

TCXO Frequency Stability

The SiT1552 is factory calibrated (trimmed) over multiple temperature points to guarantee extremely tight stability over temperature. Unlike quartz crystals that have a classic tuning fork parabola temperature curve with a 25°C turnover point with a 0.04 ppm/C2 temperature coefficient, the SiT1552 temperature coefficient is calibrated and corrected over temperature with an active temperature correction circuit. The result is 32 kHz TCXO with extremely tight frequency variation over the -40°C to +85°C temperature range. Contact SiTime for applications that require a wider supply voltage range >3.63V, or lower operating frequency below 32 kHz.

When measuring the SiT1552 output frequency with a frequency counter, it is important to make sure the counter's gate time is >100 ms. The slow frequency of a 32kHz clock will give false readings with faster gate times.

Power Supply Noise Immunity

In addition to eliminating external output load capacitors common with standard XTALs, this device includes special power supply filtering and thus, eliminates the need for an external Vdd bypass-decoupling capacitor to keep the footprint as small as possible. Internal power supply filtering is designed to reject more than ± 150 mV noise and frequency components from low frequency to more than 10 MHz.

Start-up and Steady-State Supply Current

The SiT1552 TCXO starts-up to a valid output frequency within 300 ms (180 ms typ). To ensure the device starts-up within the specified limit, make sure the power-supply ramps-up in approximately 10 - 20 ms (to within 90% of Vdd).

During initial power-up, the SiT1552 power-cycles internal blocks, as shown in the power-supply start-up and steady state plot in the Typical Operating Curves section. Power-up and initialization is typically 200 ms, and during that time, the peak supply current reaches 28 μ A as the internal capacitors are charged, then sequentially drops to its 990 nA steady-state current. During steady-state operation, the internal temperature compensation circuit turns on every 350 ms for a duration of approximately 10 ms.

Output Voltage

The SiT1552 has two output voltage options. One option is a standard LVCMOS output swing. The second option is the NanoDrive reduced swing output. Output swing is customer specific and programmed between 200 mV and 800 mV. For DC-coupled applications, output V_{OH} and V_{OL} are individually factory programmed to the customers' requirement. V_{OH} programming range is between 600 mV and 1.225V in 100 mV increments. Similarly, V_{OL} programming range is between 350 mV and 800 mV. For example; a PMIC or MCU is internally 1.8V logic compatible, and requires a 1.2V V_{IH} and a 0.6V V_{IL}. Simply select SiT1552 NanoDrive factory programming code to be "D14" and the correct output thresholds will match the downstream PMIC or MCU input requirements. Interface logic will vary by manufacturer and we recommend that you review the input voltage requirements for the input interface.

For DC-biased NanoDrive output configuration, the minimum V_{OL} is limited to 350mV and the maximum allowable swing $(V_{OH} - V_{OL})$ is 750 mV. For example, 1.1V V_{OH} and 400 mV V_{OL} is acceptable, but 1.2V V_{OH} and 400 mV V_{OL} is not acceptable. When the output is interfacing to an XTAL input that is internally AC-coupled, the SiT1552 output can be factory programmed to match the input swing requirements. For example, if a PMIC or MCU input is internally AC-coupled and requires an 800 mV swing, then simply choose the SiT1552 NanoDrive programming code "AA8" in the part number. It is important to note that the SiT1552 does not include internal AC-coupling capacitors. Please see the Part Number Ordering section at the end of the datasheet for more information about the part number ordering scheme.

SiT1552 NanoDrive[™]

Figure 2 shows a typical output waveform of the SiT1552 (into a 10 pF load) when factory programmed for a 0.70V swing and DC bias (V_{OH}/V_{OL}) for 1.8V logic:

Example:

- NanoDrive[™] part number coding: D14. Examplepart number: SiT1552AI-JE-<u>D14</u>-32.768
- V_{OH} = 1.1V, V_{OL} = 0.4V (V_{_sw} = 0.70V)

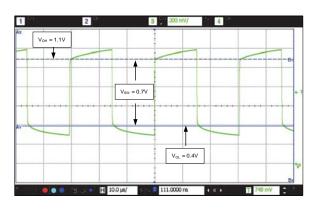


Figure 2. SiT1552AI-JE-<u>D14</u>-32.768 Output Waveform (10 pF load)

Table 1 shows the supported NanoDriveTM V_{OH} , V_{OL} factory programming options.

NanoDrive	V _{OH} (V)	V _{OL} (V)	Swing (mV)	Comments
D26	1.2	0.6	600 ±55	1.8V logic compatible
D14	1.1	0.4	700 ±55	1.8V logic compatible
D74	0.7	0.4	300 ±55	XTAL compatible
AA3	n/a	n/a	300 ±55	XTAL compatible

The values listed in Tables 1 are nominal values at 25° C and will exhibit a tolerance of $\pm 55 \text{ mV}$ across Vdd and - 40° C to 85° C operating temperature range.

SiT1552 Full Swing LVCMOS Output

The SiT1552 can be factory programmed to generate fullswing LVCMOS levels. Figure 3 shows the typical waveform (Vdd = 1.8V) at room temperature into a 15 pF load.

Example:

- LVCMOS output part number coding is always DCC
- Example part number: SiT1552AI-JE-DCC-32.768

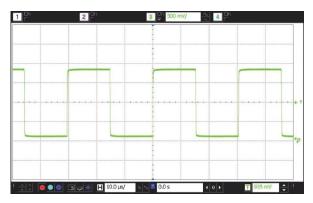


Figure 3. LVCMOS Waveform (Vdd = 1.8V) into 15 pF Load

Calculating Load Current

No Load Supply Current

When calculating no-load power for the SiT1552, the core and output driver components need to be added. Since the output voltage swing can be programmed to minimize load current, the output driver current is variable. Therefore, noload operating supply current is broken into two sections; core and output driver. The equation is as follows:

Total Supply Current (no load) = Idd Core + Idd Output Driver

Example 1: Full-swing LVCMOS

- Vdd = 1.8V
- Idd Core = 990nA (typ)
- Vout_{pp} = 1.8V
- Idd Output Driver: (Cdriver)(Vout)(Fout) = (3.5pF)(1.8V)(32768Hz) = 206nA

Supply Current = 990nA + 206nA = 1.2µA

Example 2: NanoDrive™ Reduced Swing

- Vdd = 1.8V
- Idd Core = 990nA (typ)
- $Vout_{pp} (D14) = V_{OH} V_{OL} = 1.1V 0.4V = 700 mV$
- Idd Output Driver: (Cdriver)(Vout)(Fout) = (3.5pF)(0.7V)(32768Hz) = 80nA

Supply Current = 990nA + 80nA = 1.07µA

Total Supply Current with Load

To calculate the total supply current, including the load, follow the equation listed below.

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Total Current = Idd Core + Idd Output Driver + Load Current

Example 2: Full-swing LVCMOS

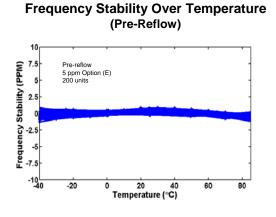
- Vdd = 1.8V
- Idd Core = 990n
- Load Capacitance = 10pF
- Idd Output Driver: (Cdriver)(Vout)(Fout) = (3.5pF)(1.8V)(32768Hz) = 206nA
- Load Current: (10pF)(1.8V)(32768Hz) = 590nA
- Total Current = 990nA + 206nA + 590nA = 1.79µA

Example 2: NanoDrive™ Reduced Swing

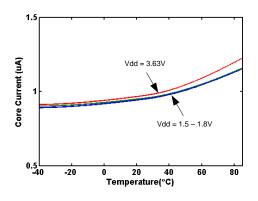
- Vdd = 1.8V
- Idd Core = 990nA
- Load Capacitance = 10pF
- Vout_{pp} (D14): V_{OH} V_{OL} = 1.1V 0.4V = 700mV
- Idd Output Driver: (Cdriver)(Vout)(Fout) = (3.5pF)(0.7V)(32768Hz) = 80nA
- Load Current: (10pF)(0.7V)(32.768kHz) = 229nA
- Total Current = 990nA + 80nA + 229nA = 1.299µA

Typical Operating Curves

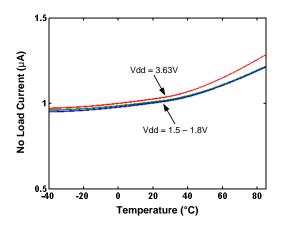
($T_A = 25^{\circ}C$, Vdd = 1.8V, unless otherwise stated)

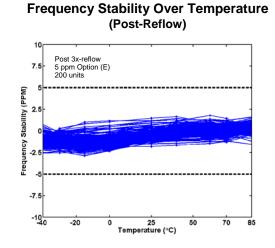


Core Current Over Temperature

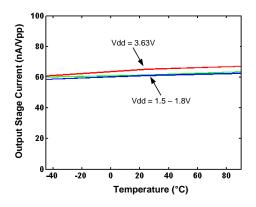


Total Supply Current Over Temperature, LVCMOS (Core + LVCMOS Output Driver, No Load)

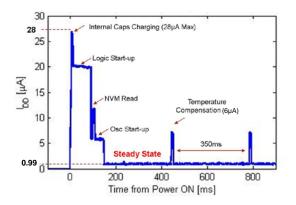








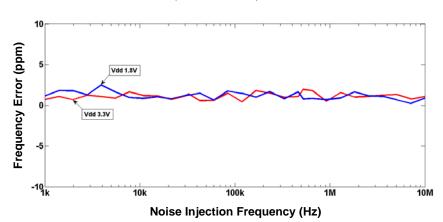
Start-up and Steady-State Current Profile



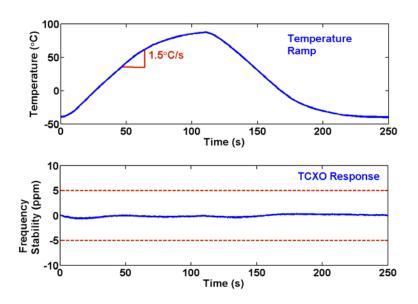


Power Supply Noise Rejection

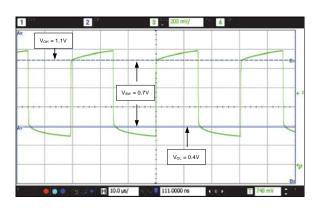
(±150mV Noise)



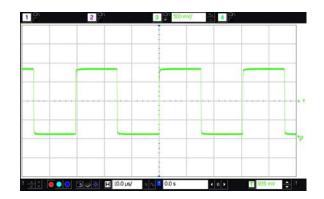
Temperature Ramp Response



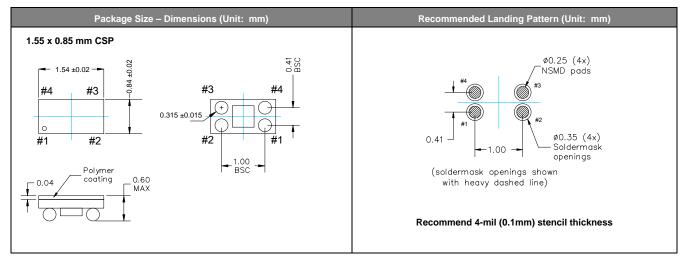
NanoDrive™ Output Waveform (VOH = 1.1V, VOL = 0.4V; SiT1552AI-JE-D14-32.768)



LVCMOS Output Waveform (Vswing = 1.8V, SiT1552AI-JE-DCC-32.768, 10 pF Load)



Dimensions and Patterns



Manufacturing Guidelines

1) No Ultrasonic Cleaning: Do not subject the SiT1552 to an ultrasonic cleaning environment. Permanent damage or long term reliability issues to the MEMS structure may occur.

2) Do not apply underfill to the SiT1552. The device will not meet the frequency stability specification if underfill is applied.

3) Reflow profile, per JESD22-A113D.

4) For additional manufacturing guidelines and marking/tape-reel instructions, click on the following link:

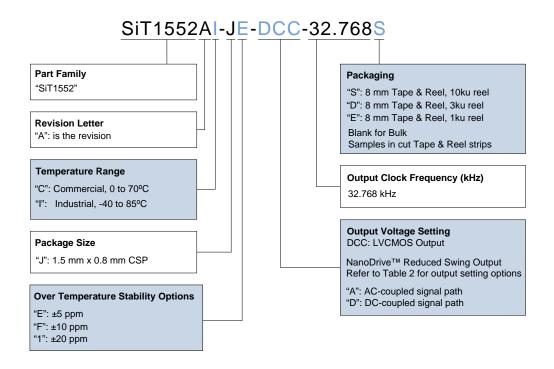
http://www.sitime.com/component/docman/doc_download/243-manufacturing-notes-for-sitime-oscillators

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Ordering Information

Part number characters in blue represent the customer specific options. The other characters in the part number are fixed.



The following examples illustrate how to select the appropriate temp range and output voltage requirements:

Example 1: SiT1552AI-JE-DCC-32.768

- Industrial temperature range
- CSP package
- 5ppm frequency stability over temp
- Output swing requirements:
 - a) Output frequency = 32.769 kHz
 - b) "D" = DC-coupled receiver
 - c) "C" = LVCMOS output swing
 - d) "C" = LVCMOS output swing

Example 2: SiT1552AC-JF-D14-32.768

- Commercial temperature range
- CSP package
- 10ppm frequency stability over temp
- Output swing requirements:
 - a) Output frequency = 32.769 kHz
 - b) "D" = DC-coupled receiver
 - c) "1" = V_{OH} = 1.1V
 - d) "4" = V_{OL} = 400mV

NanoDrive	V _{OH} (V)	V _{OL} (V)	Swing (mV)	Comments
D26	1.2	0.6	600 ±55	1.8V logic compatible
D14	1.1	0.4	700 ±55	1.8V logic compatible
D74	0.7	0.4	300 ±55	XTAL compatible
AA3	n/a	n/a	300 ±55	XTAL compatible

Table 2. Acceptable V_{OH}/V_{OL} NanoDrive[™] Levels^[4]

Note:

4. If these available options do not accommodate your application, contact Factory for other NanoDrive options.



Revision History

Version	Release Date	Change Summary
1.0	9/17/14	 Rev 0.9 Preliminary to Rev 1.0 Production Release Updated start-up time specification Added typical operating plots Removed SOT23 and 2012 SMD package options Added "no underfill" in frequency stability specification condition Added Manufacturing Guidelines section
1.1	10/14/14	 Improved Start-up Time at Power-up spec Added 5pF LVCMOS rise/fall time spec
1.2	11/10/14	Updated 5pF LVCMOS rise/fall time spec
1.25	6/3/16	 Updated NanoDrive section Updated first year aging spec condition Added 10-year and 20-year aging spec

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